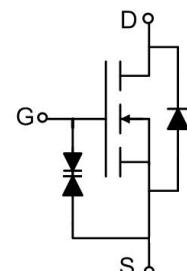
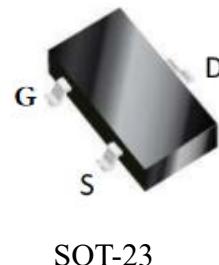


Features

- ◆ 60V,0.32A, $R_{DS(ON)}$ (Typ.)=2.2Ω@ $V_{GS} = 10V$.
- ◆ Very Low Leakage Current In Off Condition.
- ◆ ESD Protected 2KV HBM.



Application

- ◆ Power switching application
- ◆ Hard switched and high frequency circuits

Absolute Maximum Ratings $T_c = 25^\circ C$ unless otherwise noted

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage	60	V
V_{GS}	Gate-Source Voltage	± 20	
I_D	Drain Current-Continuous, $T_A = 25^\circ C$	320	mA
I_{DM}	Drain Current-Pulsed ^a	2000	
P_D	Maximum Power Dissipation @ $T_A = 25^\circ C$	350	mW
T_{STG}	Store Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient Max ^c	357	°C/W

Electrical Characteristics $T_J = 25^\circ C$ unless otherwise noted

■ Off Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	60	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 60V, V_{GS} = 0V$	-	-	1	μA
I_{GSS}	Forward Gate Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	± 10	μA

**MU6001T**

N-Channel Enhancement Mode MOSFET

■ On Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	1.0	1.5	2.1	V
$R_{DS(on)}$	Static Drain-Source On-Resistance ^a	$V_{GS} = 5V$, $I_D = 50mA$	-	-	2.8	Ω
		$V_{GS} = 4.5V$, $I_D = 200mA$	-	-	3.2	
		$V_{GS} = 10V$, $I_D = 500mA$	-	-	3.0	
g_{fs}	Forward Transconductance	$V_{DS}=15V$, $I_D=250mA$	300	-	-	mS

■ Dynamic Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
C_{iss}	Input Capacitance	$V_{DS} = 25V$, $V_{GS} = 0V$, $f = 1.0MHz$	-	-	35	pF
C_{oss}	Output Capacitance		-	-	12	
C_{rss}	Reverse Transfer Capacitance		-	-	7	

■ On Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-On Delay Time	$V_{DD}=30V$, $R_L=150\Omega$, $I_D=200mA$, $R_G=10\Omega$, $V_{GS}=10V$	-	6	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	13	-	
Q_g	Total Gate Charge	$V_{DS}=15V$, $I_D=200mA$, $V_{GS}=5V$	-	-	0.8	nC

■ Drain-Source Diode Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
V_{SD}	Diode Forward Voltage	$V_{GS} = 0V$, $I_{SD} = 1A$	-	0.82	1.1	V
I_s	Continuous Source Current		-	-	300	mA

Notes:

- a: Max. current is limited by junction temperature.
- b: Pulse test (pulse width≤300us, duty cycle≤2%).

■ Typical Characteristics

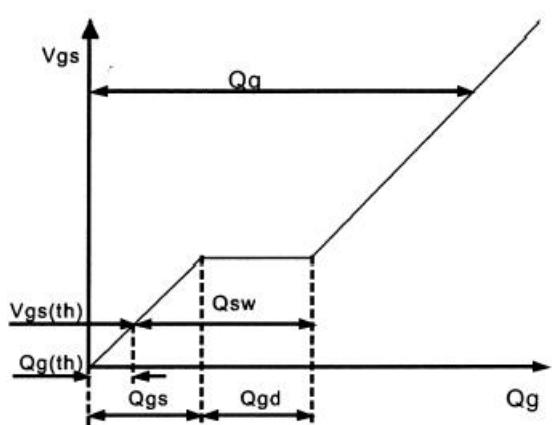
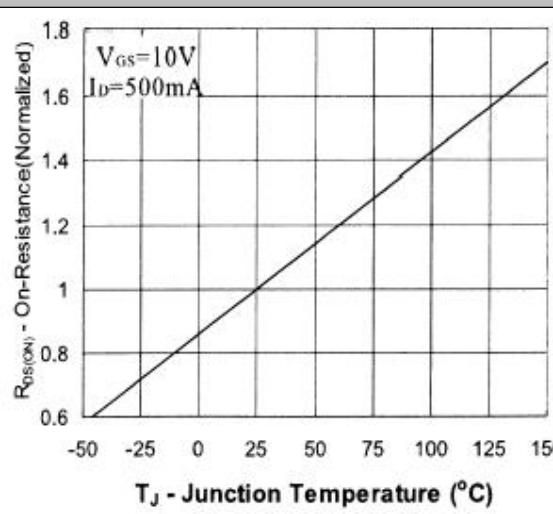
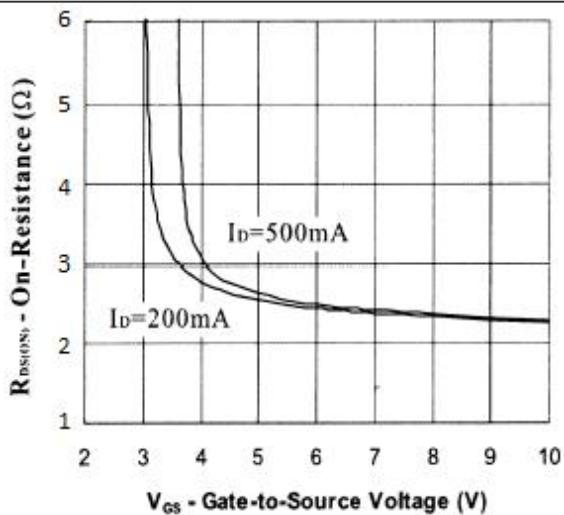
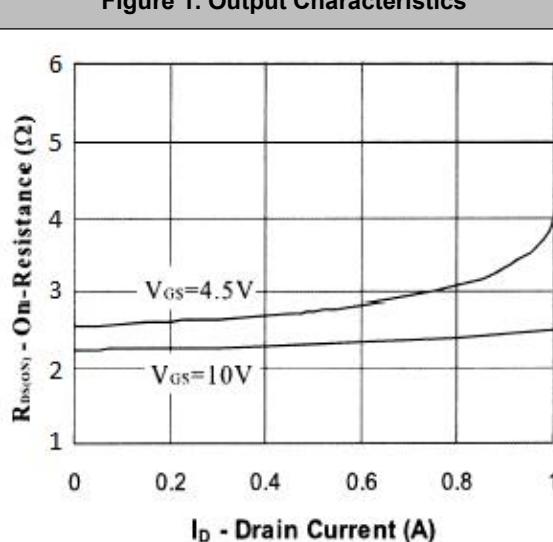
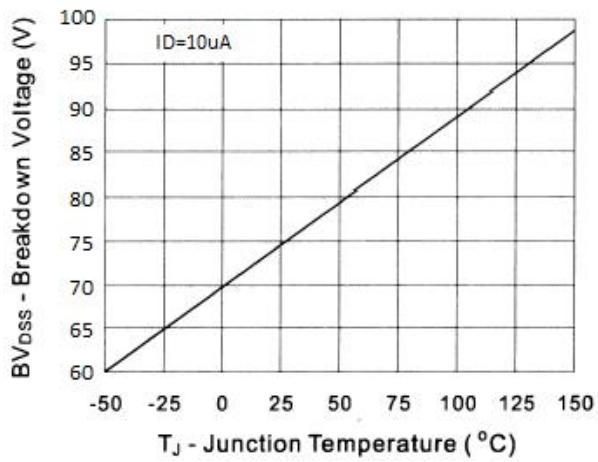
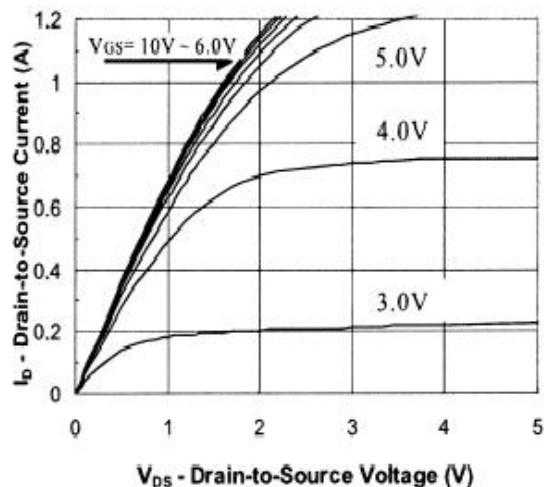
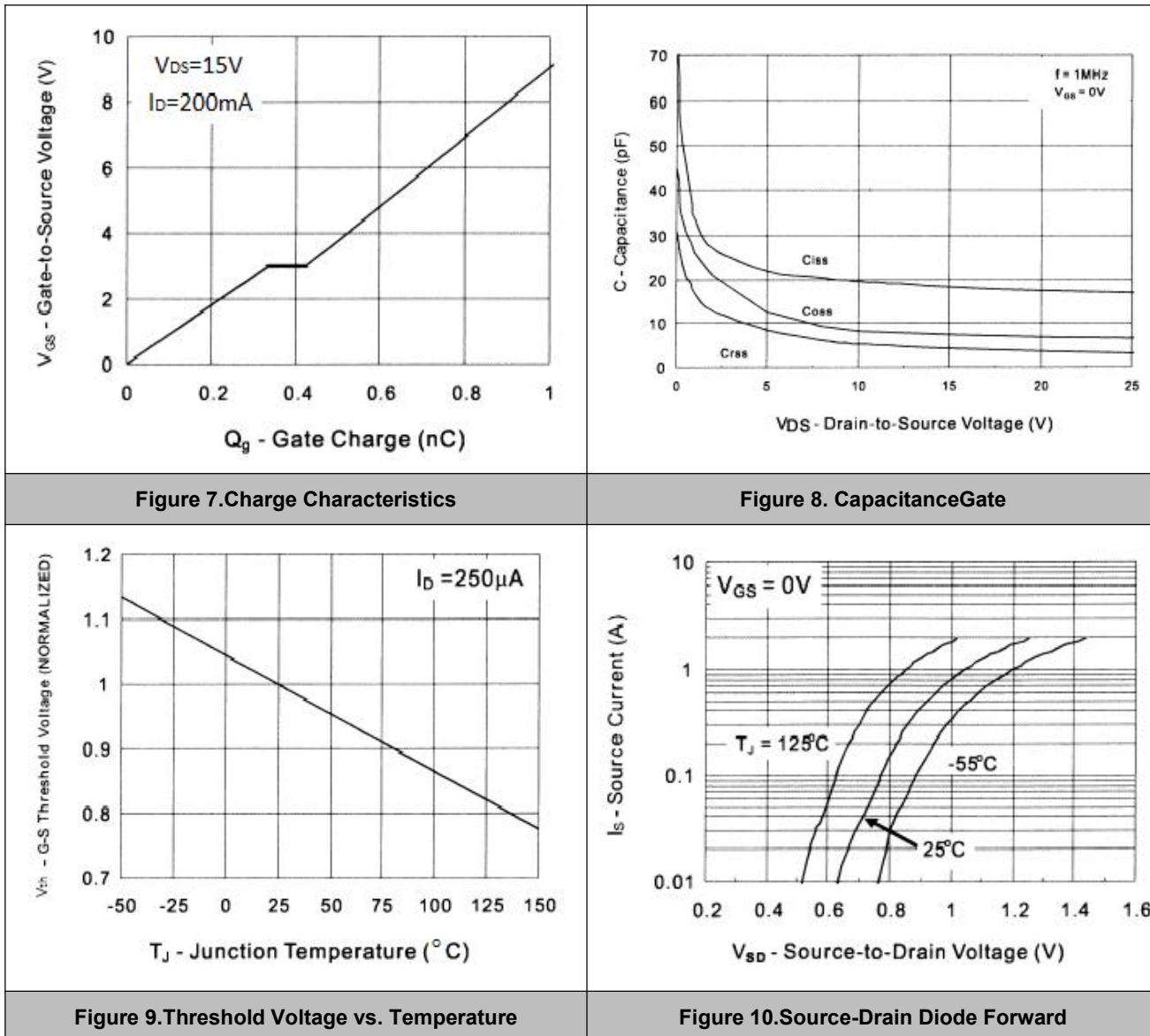


Figure 5. On-Resistance vs. Junction Temperature

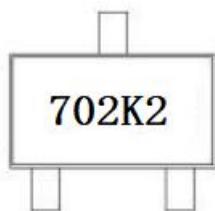
Figure 6. Gate Charge Waveform

■ Typical Characteristics



■ Marking Information

SOT-23



Mechanical Data

- Case: SOT-23
- Marking: 702K2